

IGBT - Field Stop

650 V, 60 A

FGA60N65SMD

General Description

Using Novel Field Stop IGBT Technology, **onsemi**'s new series of Field Stop IGBTs offer the optimum performance for Solar Inverter, UPS, SMPS, Welder and PFC applications where low conduction and switching losses are essential.

Features

- Maximum Junction Temperature: $T_J = 175^{\circ}C$
- Positive Temperature Co-efficient for Easy Parallel Operating
- High Current Capability
- Low Saturation Voltage: $V_{CE(sat)} = 1.9 \text{ V(Typ.)}$ @ $I_C = 60 \text{ A}$
- Fast Switching: $E_{OFF} = 7.5 \mu J/A$
- Tighten Parameter Distribution
- This Device is Pb-Free and is RoHS Compliant

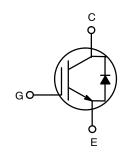
Applications

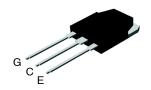
• Solar Inverter, UPS, SMPS, Welder, PFC

ABSOLUTE MAXIMUM RATINGS

Symbol	Rating		Value	Unit
V _{CES}	Collector to Emitter Voltage		650	V
V_{GES}	Gate to Emitter Voltage		±20	V
	Transient Gate to Emitter V	oltage	±30	V
I _C	Collector Current	Collector Current T _C = 25°C		Α
		T _C = 100°C	60	Α
I _{CM}	Pulsed Collector Current (N	Pulsed Collector Current (Note 1)		
I _F	Diode Forward Current T _C = 25°C		60	Α
		T _C = 100°C	30	Α
I _{FM}	Pulsed Diode Maximum Fo (Note 1)	180	Α	
P _D	Maximum Power $T_C = 25^{\circ}C$		600	W
	Dissipation	T _C = 100°C	300	W
TJ	Operating Junction Temper	−55 to +175	°C	
T _{stg}	Storage Temperature Range		−55 to +175	°C
T _L	Maximum Lead Temp. for S Purposes, 1/8" from Case for	300	°C	

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.





TO-3P-3LD / EIAJ SC-65, ISOLATED CASE 340BZ

MARKING DIAGRAM



FGA60N65SMD = Specific Device Code A = Assembly Location

YWW = Date Code (Year & Work Week)

ZZ = Lot Code

ORDERING INFORMATION

Device	Package	Shipping		
FGA60N65SMD	TO-3P-3L	450 / Box		

^{1.} Repetitive rating: Pulse width limited by max. junction temperature

THERMAL CHARACTERISTICS

Symbol	Characteristic	Value	Unit
$R_{\theta JC}$ (IGBT)	Thermal Resistance, Junction to Case	0.25	°C/W
$R_{\theta JC}(Diode)$	Thermal Resistance, Junction to Case	1.1	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient	40	°C/W

ELECTRICAL CHARACTERISTICS OF THE IGBT (T_C = 25°C unless otherwise noted)

Symbol	Parameter	Test Condition	Min.	Тур.	Max.	Unit	
OFF CHARACTERISTICS							
BV _{CES}	Collector to Emitter Breakdown Voltage	V _{GE} = 0 V, I _C = 250 μA	650	-	_	V	
$\frac{\Delta BV_CES}{\Delta T_J}$	Temperature Coefficient of Breakdown Voltage	$V_{GE} = 0 \text{ V, } I_{C} = 250 \mu\text{A}$	_	0.6	-	V/°C	
I _{CES}	Collector Cut-Off Current	V _{CE} = V _{CES} , V _{GE} = 0 V	-	-	250	μΑ	
I _{GES}	G-E Leakage Current	V _{GE} = V _{GES} , V _{CE} = 0 V	-	-	±400	nA	
ON CHARAC	CTERISTICS						
V _{GE(th)}	G-E Threshold Voltage	$I_C = 250 \mu A, V_{CE} = V_{GE}$	3.5	4.5	6.0	V	
V _{CE(sat)}	Collector to Emitter Saturation Voltage	I _C = 60 A, V _{GE} = 15 V	-	1.9	2.5	V	
		I _C = 60 A, V _{GE} = 15 V, T _C = 175°C	-	2.1	-	V	
DYNAMIC C	HARACTERISTICS						
C _{ies}	Input Capacitance	V _{CE} = 30 V, V _{GE} = 0 V, f = 1 MHz	-	2915	_	pF	
C _{oes}	Output Capacitance		-	270	_	pF	
C _{res}	Reverse Transfer Capacitance		-	85	_	pF	
SWITCHING	CHARACTERISTICS						
t _{d(on)}	Turn-On Delay Time	V _{CC} = 400 V, I _C = 60 A, V _{GE} = 15 V,	-	18	27	ns	
t _r	Rise Time	$R_G = 3 \Omega$, Inductive Load, $T_C = 25^{\circ}C$	-	47	70	ns	
t _{d(off)}	Turn-Off Delay Time		-	104	146	ns	
t _f	Fall Time		-	50	68	ns	
E _{on}	Turn-On Switching Loss		-	1.54	2.31	mJ	
E _{off}	Turn-Off Switching Loss		-	0.45	0.60	mJ	
E _{ts}	Total Switching Loss		-	1.99	2.91	mJ	
t _{d(on)}	Turn-On Delay Time	V _{CC} = 400 V, I _C = 60 A, V _{GE} = 15 V,	_	18	_	ns	
t _r	Rise Time	$R_G = 3 \Omega$, Inductive Load, $T_C = 175^{\circ}C$	-	41	_	ns	
t _{d(off)}	Turn-Off Delay Time		-	115	_	ns	
t _f	Fall Time		-	48	_	ns	
E _{on}	Turn-On Switching Loss		-	2.08	-	mJ	
E _{off}	Turn-Off Switching Loss		-	0.78	-	mJ	
E _{ts}	Total Switching Loss		-	2.86	-	mJ	
Qg	Total Gate Charge	V _{CE} = 400 V, I _C = 60 A, V _{GE} = 15 V	-	189	284	nC	
Q _{ge}	Gate to Emitter Charge		_	20	30	nC	
Q _{gc}	Gate to Collector Charge		_	91	137	nC	

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

ELECTRICAL CHARACTERISTICS OF THE DIODE ($T_C = 25$ °C unless otherwise noted)

Symbol	Parameter	Test Condition		Min.	Тур.	Max.	Unit
V_{FM}	Diode Forward Voltage	I _F = 30 A	T _C = 25°C	-	2.1	2.6	٧
			T _C = 175°C	-	1.7	_	
E _{rec}	Reverse Recovery Energy	I _F = 30 A,	T _C = 175°C	-	127	_	μJ
t _{rr}	Diode Reverse Recovery Time	$dI_F/dt = 200 A/\mu s$	T _C = 25°C	-	47	-	ns
			T _C = 175°C	-	212	-	
Q _{rr}	Diode Reverse Recovery Charge		T _C = 25°C	-	87	-	nC
			T _C = 175°C	-	933	-	

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

TYPICAL PERFORMANCE CHARACTERISTICS

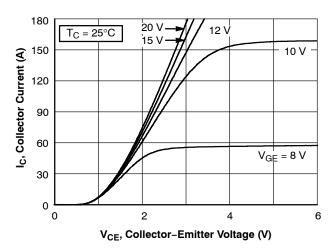


Figure 1. Typical Output Characteristics

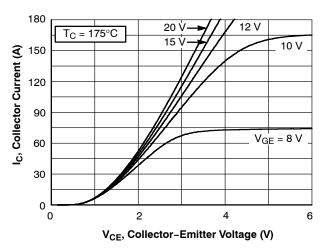


Figure 2. Typical Output Characteristics

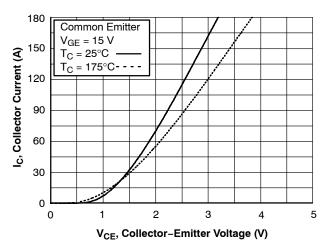


Figure 3. Typical Saturation Voltage Characteristics

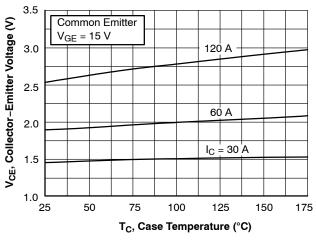


Figure 4. Saturation Voltage vs. Case Temperature at Variant Current Level

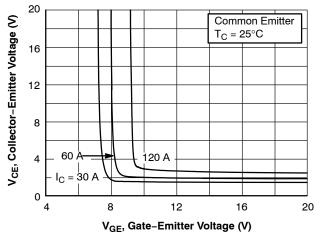


Figure 5. Saturation Voltage vs. V_{GE}

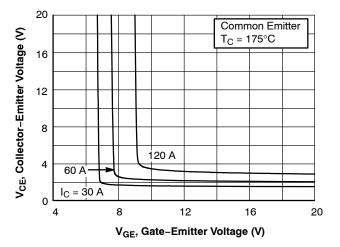


Figure 6. Saturation Voltage vs. V_{GE}

TYPICAL PERFORMANCE CHARACTERISTICS (continued)

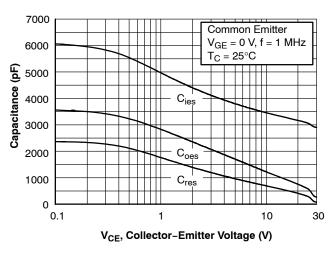


Figure 7. Capacitance Characteristics

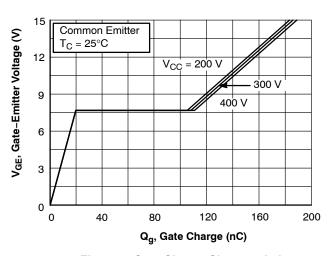


Figure 8. Gate Charge Characteristics

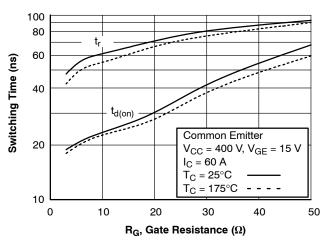


Figure 9. Turn-on Characteristics vs. Gate Resistance

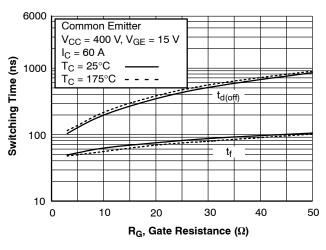


Figure 10. Turn-off Characteristics vs. Gate Resistance

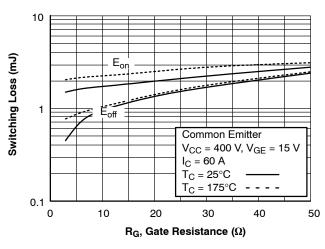


Figure 11. Switching Loss vs. Gate Resistance

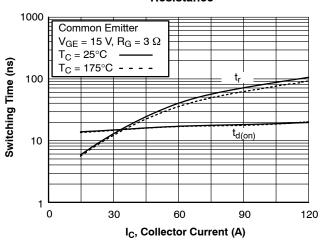


Figure 12. Turn-on Characteristics vs. Collector Current

TYPICAL PERFORMANCE CHARACTERISTICS (continued)

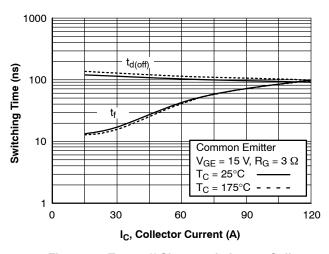


Figure 13. Turn-off Characteristics vs. Collector Current

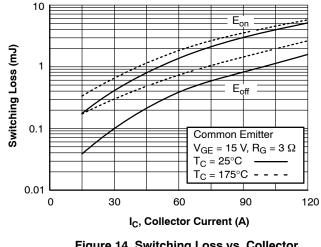


Figure 14. Switching Loss vs. Collector Current

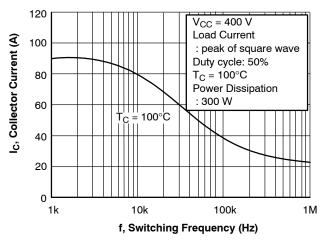


Figure 15. Load Current vs. Frequency

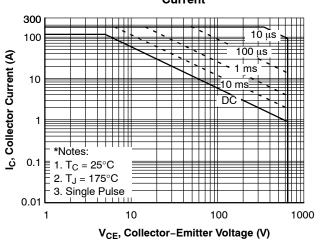


Figure 16. SOA Characteristics

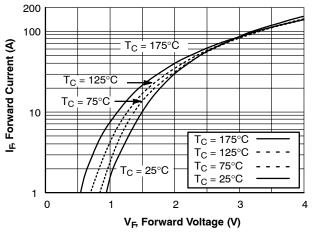


Figure 17. Forward Characteristics

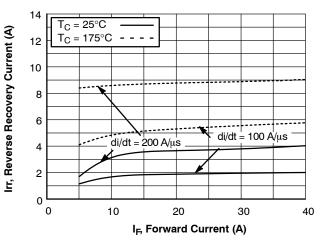
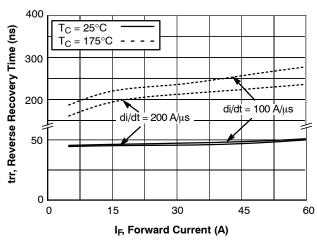


Figure 18. Reverse Recovery Current

TYPICAL PERFORMANCE CHARACTERISTICS (continued)



Qrr, Stored Recovery Charge (nC) $T_C = 25^{\circ}C$ T_C = 175°C 1200 1000 800 600 $di/dt = 200 A/\mu s$ di/dt = 100 A/μs 400 200 0 0 10 20 30 40 50 60 I_F, Forward Current (A)

Figure 19. Reverse Recovery Time

Figure 20. Stored Charge

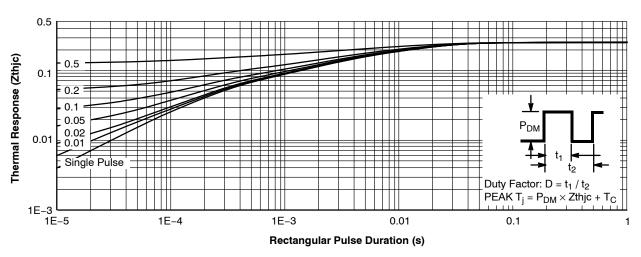


Figure 21. Transient Thermal Impedance of IGBT

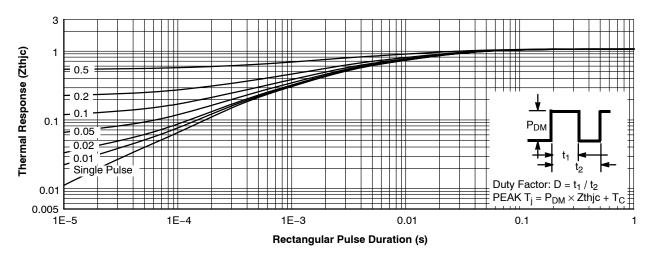
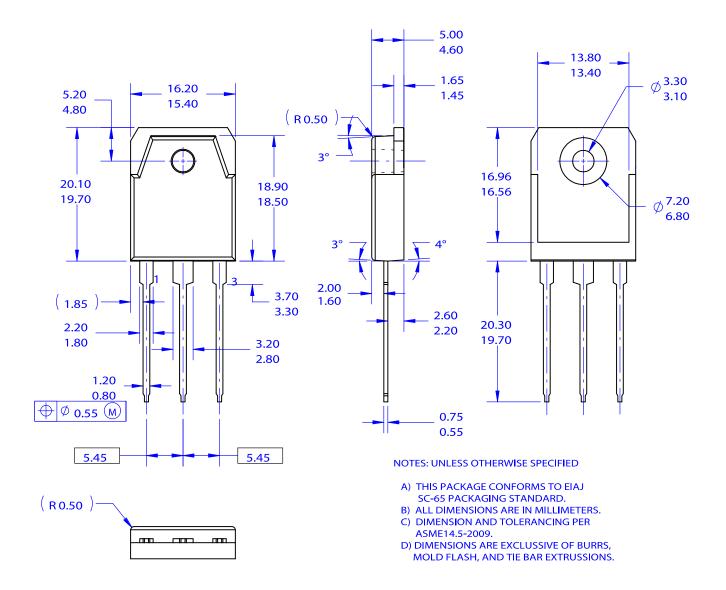


Figure 22. Transient Thermal Impedance of Diode



TO-3P-3LD / EIAJ SC-65, ISOLATED CASE 340BZ ISSUE O

DATE 31 OCT 2016



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